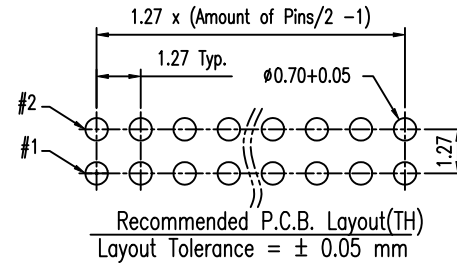


NOTE:

- MATERIAL:
HOUSING: HIGH TEMP THERMAL PLASTIC, UL94-V0
TERMINAL: COPPER ALLOY
 - FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1UM(40u")MIN NI OVER ALL
 - SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1517
 - THE HSG. WILL WITHSTAND EXPOSURE TO 260C PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION.
 - MATING SIDE LENGTH: 2.5MM MIN.
 - PRODUCT NUMBERING:
200218 1 3 - XXX XX X X LF
- LEAD FREE
PLATING:
1: G/F ALL OVER
4: 0.25UM(10U") GOLD AT CONTACT
8: 0.76UM(30U") GOLD AT CONTACT
PACKING
T: TUBE
PIN COUNT
04, 06, 08, ..., 98, A0
(EVERY EVEN PIN)
STACK HEIGHT "K"
EXAMPLE: 045=4.5MM
IN 0.5MM INCREMENT



mat'l. code		surface <input checked="" type="checkbox"/> tolerance		projection	product family 585
ltr	ecn no	dr	date	tolerances unless otherwise specified	
A	T10-0188	S.LIN	10'-10-05	 MM	title 1.27X1.27MM BTB STACK HD VT, TH
angled		lead	.X ± 0.38		
0 ± 2°		line	.XX ± 0.25		
			.XXX ± 0.10	scale N/A	
dr	STERLING LIN		10'-12-21		sheet 1 of 1 size 20021813 A4
eng	STERLING LIN		10'-12-21		
chr	STERLING LIN		10'-12-21		
app	GARY HSIEH		10'-12-21		
sheet index	revision A	sheet	1	type	CUSTOMER Drawing